

## SILICON BRIDGE RECTIFIERS

### Features

- ◆ The plastic package carries Underwriters Laboratory Flammability Classification 94V-0
- ◆ Ideal for printed circuit boards
- ◆ Low reverse leakage
- ◆ High forward surge current capability
- ◆ High temperature soldering guaranteed: 260°C/10 seconds, 5 lbs. (2.3kg) tension

**KBPC-25** 

### Mechanical Data

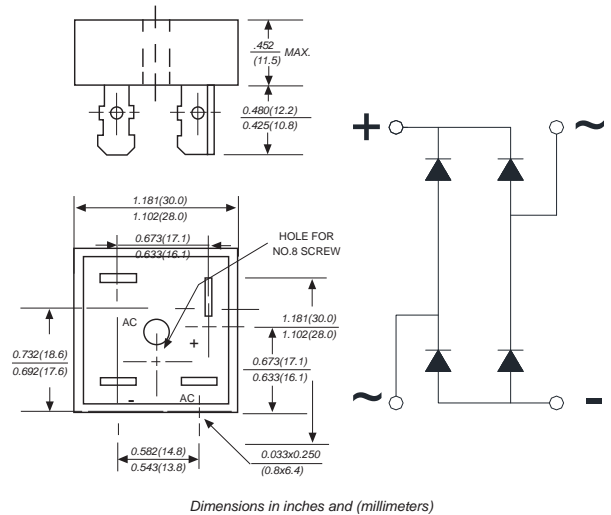
**Case** : JEDEC KBPC-25 Molded plastic body

**Terminals** : Solder plated, solderable per MIL-STD-750, Method 2026

**Polarity** : Polarity symbol marking on body

**Mounting Position** : Any

**Weight** : 1.02 ounce, 29 grams



### Maximum Ratings And Electrical Characteristics

Ratings at 25°C ambient temperature unless otherwise specified.

Single phase half-wave 60Hz, resistive or inductive load, for capacitive load current derate by 20%.

Parameter	SYMBOLS	KBPC25005	KBPC2501	KBPC2502	KBPC2504	KBPC2506	KBPC2508	KBPC2510	UNITS
Marking Code									
Maximum repetitive peak reverse voltage	$V_{RRM}$	50	100	200	400	600	800	1000	V
Maximum RMS voltage	$V_{RMS}$	30	70	140	280	420	560	700	V
Maximum DC blocking voltage	$V_{DC}$	50	100	200	400	600	800	1000	V
Maximum average forward output rectified current at $T_c=55^\circ\text{C}$ (Note 1)	$I_{(AV)}$	25.0							A
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC Method)	$I_{FSM}$	300							A
Rating for Fusing ( $t < 8.3\text{ms}$ )	$I^2t$	373							$\text{A}^2\text{s}$
Maximum instantaneous forward voltage drop per bridge element at 12.5A	$V_F$	1.1							V
Maximum DC reverse current at rated DC blocking voltage	$I_R$	10							$\mu\text{A}$
		1.0							mA
Isolation voltage from case to leads	$V_{IOS}$	2500							$V_{AC}$
Typical Thermal Resistance (Note 2)	$R_{\theta JA}$	2.0							$^\circ\text{C}/\text{W}$
Operating junction temperature range	$T_J$	-65 to +150							$^\circ\text{C}$
storage temperature range	$T_{STG}$	-65 to +150							$^\circ\text{C}$

**NOTES:**

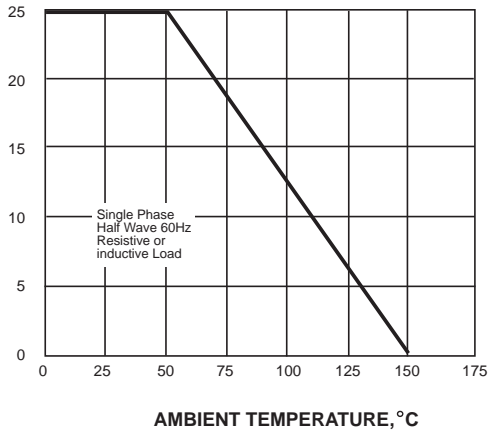
1. Unit mounted on 5" x 4" x 3" thick (12.8cm x 10.2cm x 7.3cm) Al. plate.

2. Bolt down on heat-sink with silicone thermal compound between bridge and mounting surface for maximum heat transfer efficiency with #8 screw.

## Ratings And Characteristic Curves

AVERAGE FORWARD RECTIFIED CURRENT, AMPERES

FIG. 1- FORWARD CURRENT DERATING CURVE



PEAK FORWARD SURGE CURRENT, AMPERES

FIG. 2-MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT

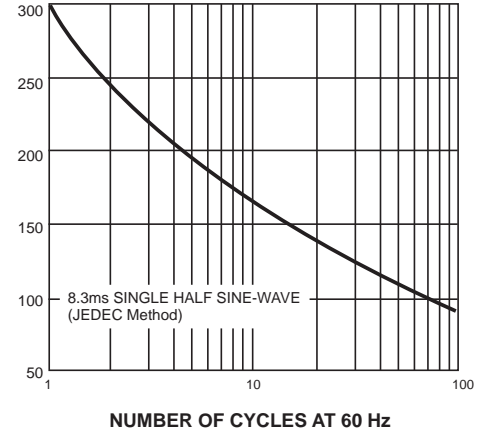


FIG. 3-TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

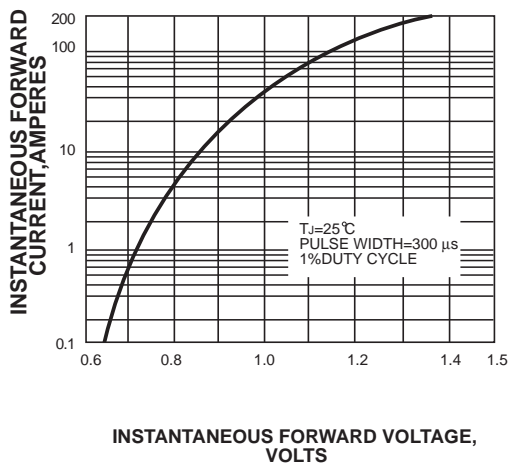


FIG. 4-TYPICAL REVERSE CHARACTERISTICS

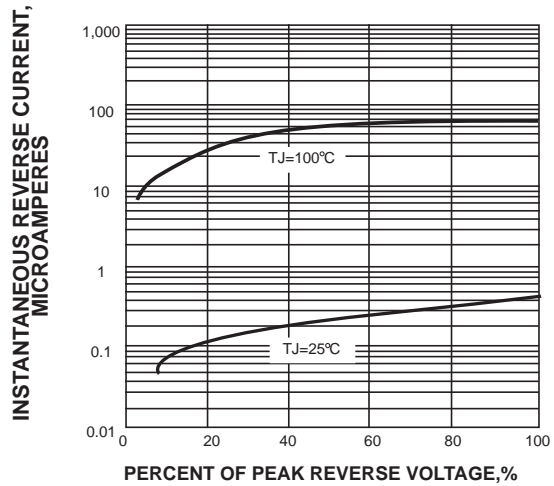
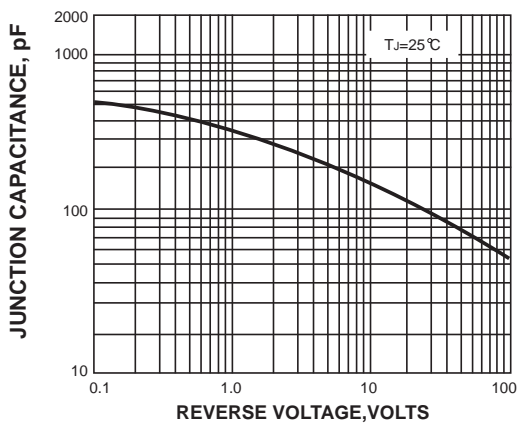
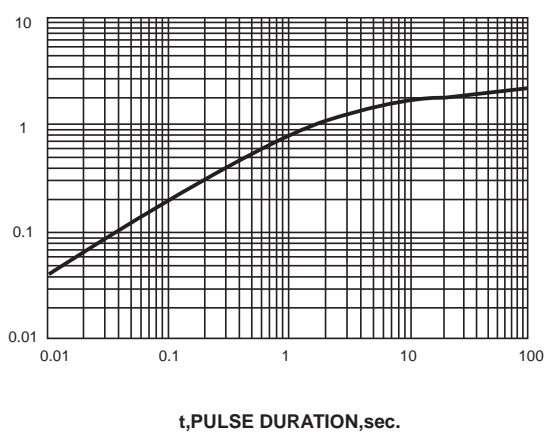


FIG. 5-TYPICAL JUNCTION CAPACITANCE



TRANSIENT THERMAL IMPEDANCE, °C/W

FIG. 6-TYPICAL TRANSIENT THERMAL IMPEDANCE



The curve above is for reference only.